

Data Sheet January 2000 File Number 3981.1

## 6A, 1200V Hyperfast Diodes

The RHRD6120 and RHRD6120S are hyperfast diodes with soft recovery characteristics ( $t_{rr}$  < 55ns). They have half the recovery time of ultrafast diodes and are silicon nitride passivated ion-implanted epitaxial planar construction.

These devices are intended for use as freewheeling/ clamping diodes and rectifiers in a variety of switching power supplies and other power switching applications. Their low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits, reducing power loss in the switching transistors.

Formerly development type TA49058.

## Ordering Information

PART NUMBER	PACKAGE	BRAND	
RHRD6120	TO-251	HR6120	
RHRD6120S	TO-252	HR6120	

NOTE: When ordering, use the entire part number. Add the suffix 9A to obtain the TO-252 variant in tape and reel, i.e., RHRD6120S9A.

## Symbol



### **Features**

- Hyperfast with Soft Recovery . . . . . . . . . <55ns • Operating Temperature......175°C
- · Planar Construction

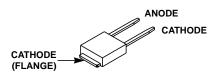
· Avalanche Energy Rated

## **Applications**

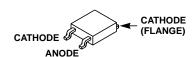
- · Switching Power Supplies
- · Power Switching Circuits
- General Purpose

## **Packaging**

**JEDEC STYLE TO-251** 



**JEDEC STYLE TO-252** 



# **Absolute Maximum Ratings** T<sub>C</sub> = 25°C, Unless Otherwise Specified

	RHRD6120, RHRD6120S	UNITS
Peak Repetitive Reverse VoltageV <sub>RRM</sub>	1200	V
Working Peak Reverse Voltage	1200	V
DC Blocking VoltageV <sub>R</sub>	1200	V
Average Rectified Forward Current $I_{F(AV)}$ ( $T_C = 130^{\circ}C$ )	6	Α
Repetitive Peak Surge Current I <sub>FRM</sub> (Square Wave, 20kHz)	12	Α
Nonrepetitive Peak Surge Current	60	Α
Maximum Power Dissipation	50	W
Avalanche Energy (See Figures 10 and 11)	10	mJ
Operating and Storage Temperature	-65 to 175	оС
Maximum Lead Temperature for Soldering		
(Leads at 0.063 in. (1.6mm) from case for 10s)	300	oC
Package Body for 10s, see Tech Brief 334	260	οС

## RHRD6120, RHRD6120S

**Electrical Specifications**  $T_C = 25^{\circ}C$ , Unless Otherwise Specified

SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
V <sub>F</sub>	I <sub>F</sub> = 6A	-	-	3.2	V
	$I_F = 6A, T_C = 150^{\circ}C$	-	-	2.6	V
I <sub>R</sub>	V <sub>R</sub> = 1200V	-	-	100	μΑ
	$V_R = 1200V, T_C = 150^{\circ}C$	-	-	500	μΑ
t <sub>rr</sub>	$I_F = 1A$ , $dI_F/dt = 200A/\mu s$	-	-	55	ns
	$I_F = 6A$ , $dI_F/dt = 200A/\mu s$	-	-	65	ns
t <sub>a</sub>	$I_F = 6A$ , $dI_F/dt = 200A/\mu s$	-	33	-	ns
t <sub>b</sub>	$I_F = 6A$ , $dI_F/dt = 200A/\mu s$	-	22	-	ns
Q <sub>RR</sub>	I <sub>F</sub> = 6A, dI <sub>F</sub> /dt = 200A/μs	-	210	-	nC
CJ	$V_{R} = 10V, I_{F} = 0A$	-	22	-	pF
$R_{ heta JC}$		-	-	3	°C/W

#### **DEFINITIONS**

 $V_F$  = Instantaneous forward voltage (pw = 300 $\mu$ s, D = 2%).

 $I_R$  = Instantaneous reverse current.

 $t_{rr}$  = Reverse recovery time (See Figure 9), summation of  $t_a + t_b$ .

t<sub>a</sub> = Time to reach peak reverse current (See Figure 9).

 $t_b$  = Time from peak  $I_{RM}$  to projected zero crossing of  $I_{RM}$  based on a straight line from peak  $I_{RM}$  through 25% of  $I_{RM}$  (See Figure 9).

Q<sub>RR</sub> = Reverse recovery charge.

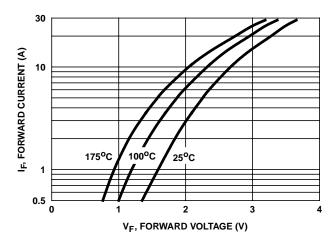
C<sub>J</sub> = Junction Capacitance.

 $R_{\theta JC}$  = Thermal resistance junction to case.

pw = Pulse Width.

D = Duty Cycle.

# **Typical Performance Curves**





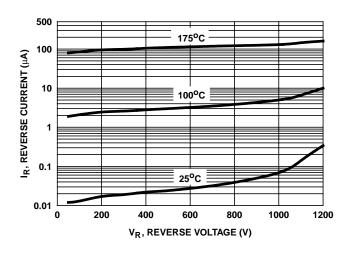


FIGURE 2. REVERSE CURRENT vs REVERSE VOLTAGE

# Typical Performance Curves (Continued)

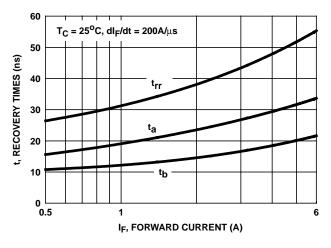


FIGURE 3.  $t_{\rm rr}, t_{\rm a}$  and  $t_{\rm b}$  curves vs forward current

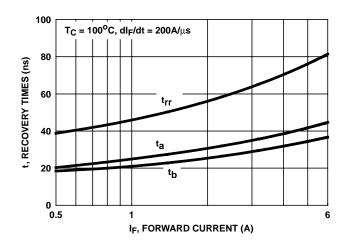


FIGURE 4.  $t_{rr}$ ,  $t_a$  AND  $t_b$  CURVES vs FORWARD CURRENT

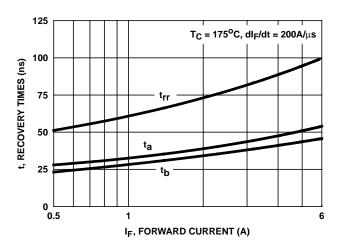


FIGURE 5.  $t_{rr}$ ,  $t_a$  AND  $t_b$  CURVES vs FORWARD CURRENT

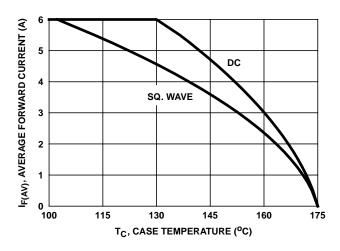


FIGURE 6. CURRENT DERATING CURVE

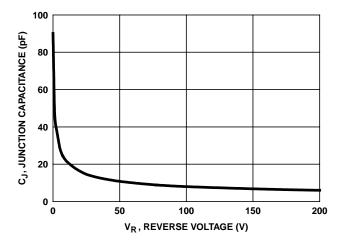


FIGURE 7. JUNCTION CAPACITANCE vs REVERSE VOLTAGE

### Test Circuits and Waveforms

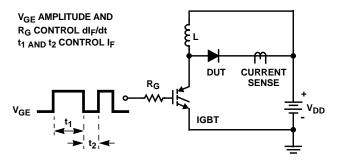


FIGURE 8. t<sub>rr</sub> TEST CIRCUIT

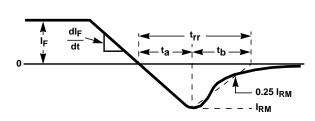


FIGURE 9. t<sub>rr</sub> WAVEFORMS AND DEFINITIONS

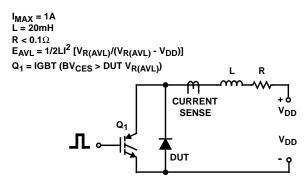


FIGURE 10. AVALANCHE ENERGY TEST CIRCUIT

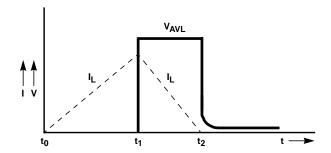


FIGURE 11. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

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